



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : Confirmation No. 5253
Kazuhiro NOBORI et al. : Docket No. 2000-1645A
Serial No. 09/722,737 : [Group Art Unit 2822
Filed November 28, 2000 : Examiner K. Rose]

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SEMICONDUCTOR PACKAGE AND METHOD FOR FORMING SEMICONDUCTOR PACKAGE

SUBMISSION OF FORMAL DRAWINGS

Assistant Commissioner for Patents,
Washington, DC 20231

**THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975**

Sir:

Four sheets of formal (A4P) drawings (Figs. 6, 7A, 7B, 10, 11A, 11B and 12) are submitted
herewith.

Respectfully submitted,

Kazuhiro NOBORI et al.

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August 28, 2002

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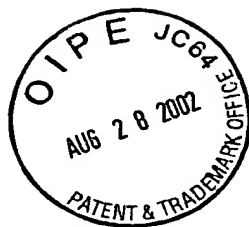


Fig. 4

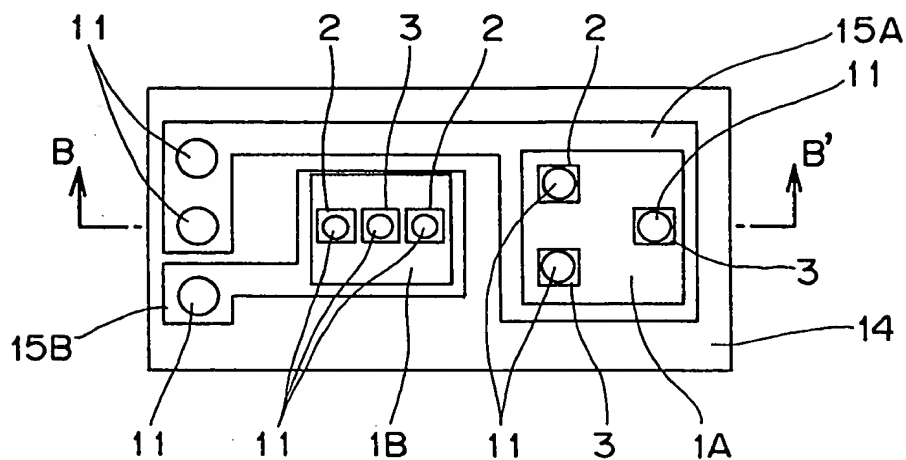


Fig. 5

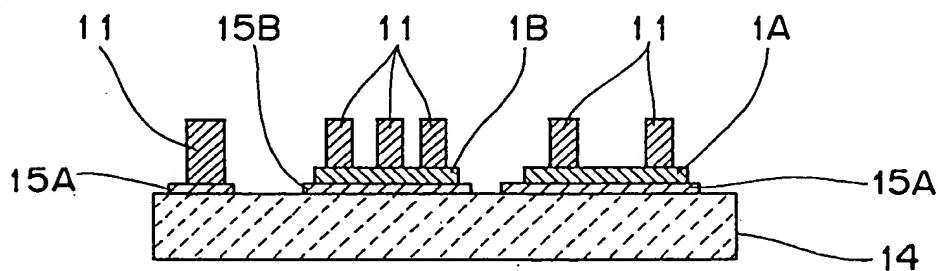


Fig. 6

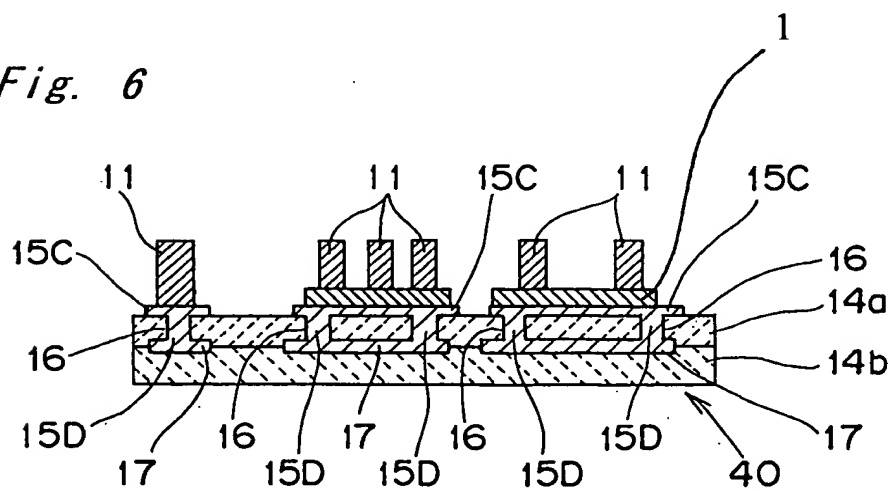




Fig. 7A

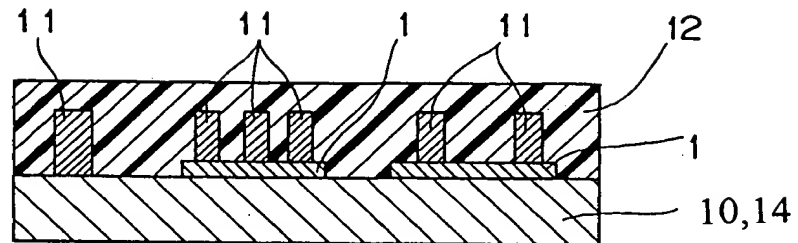


Fig. 7B

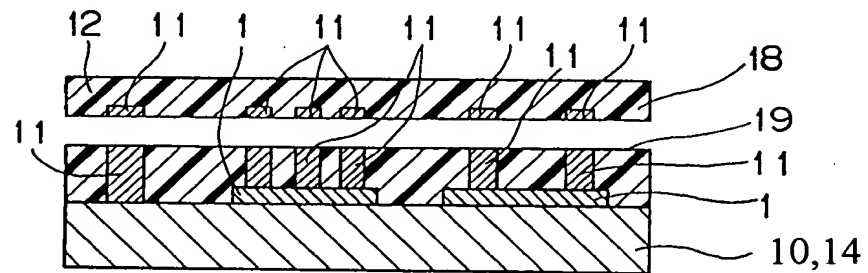


Fig. 8A

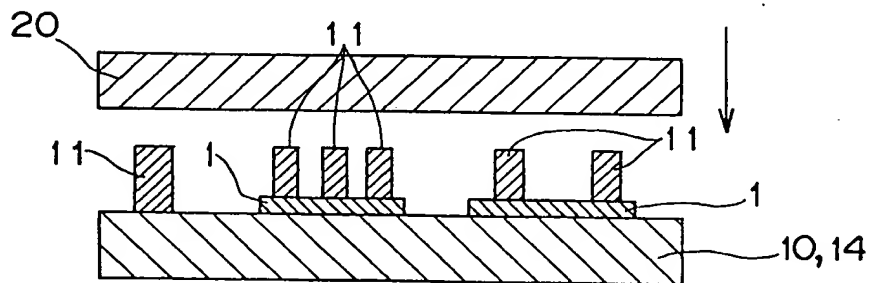


Fig. 8B

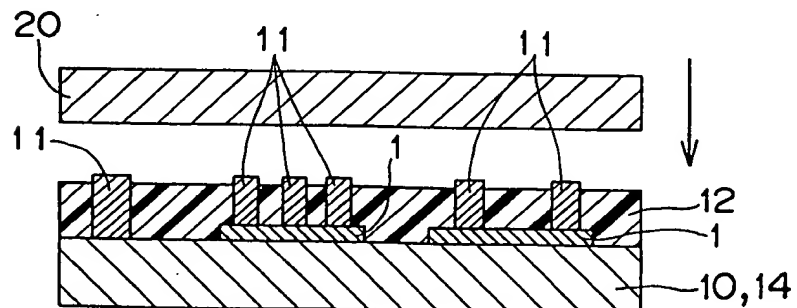




Fig. 9A

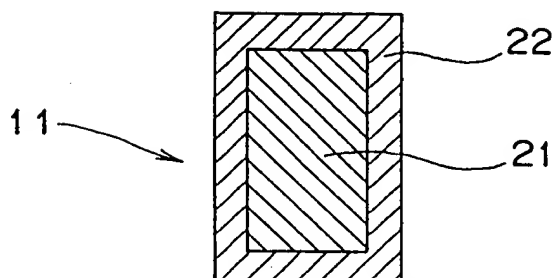


Fig. 9B

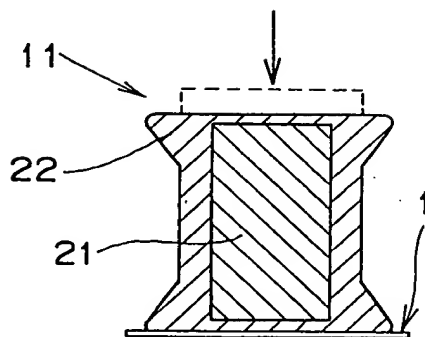


Fig. 9C

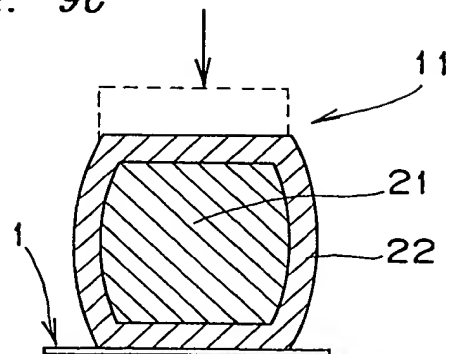


Fig. 10

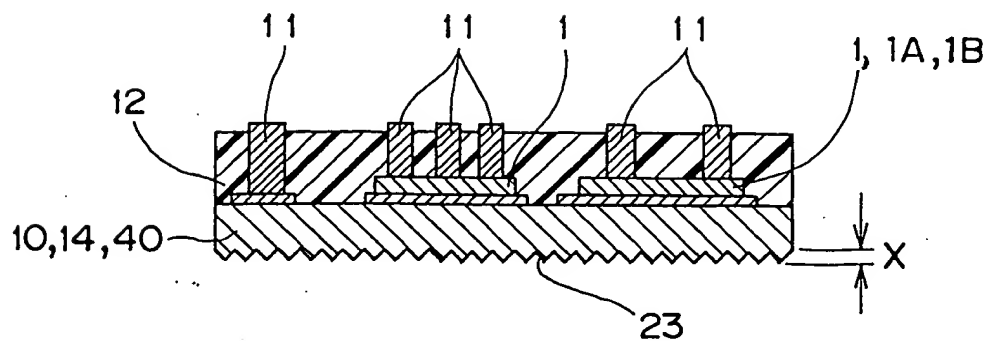




Fig. 11A

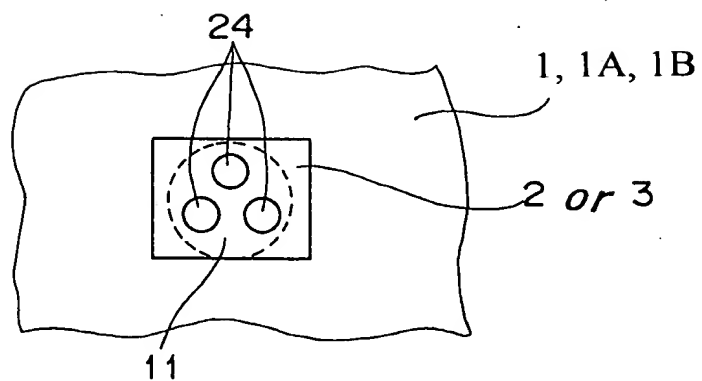


Fig. 11B

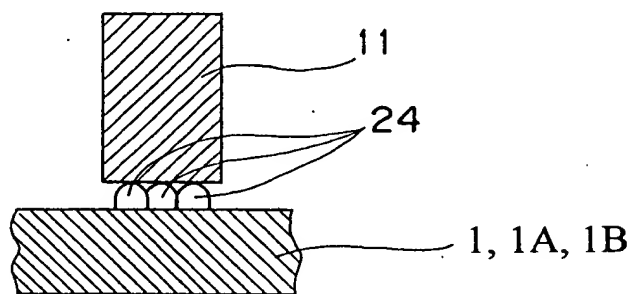


Fig. 12
PRIOR ART

